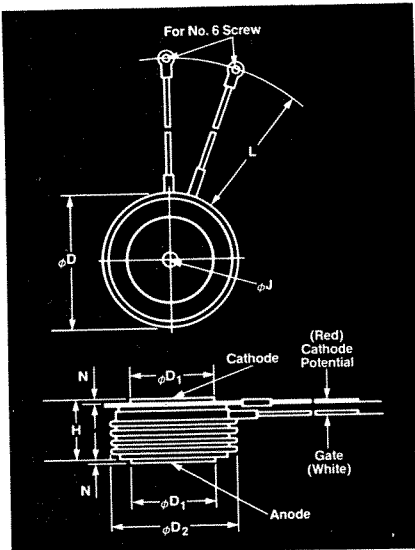


# Fast Switching SCR T82F

750A Avg.  
(1180A RMS)  
Up to 1200 Volts  
25-60  $\mu$ s



| Symbol     | Inches |       | Millimeters |        |
|------------|--------|-------|-------------|--------|
|            | Min.   | Max.  | Min.        | Max.   |
| $\phi D$   | 2.250  | 2.290 | 57.15       | 58.17  |
| $\phi D_1$ | 1.333  | 1.343 | 33.86       | 34.11  |
| $\phi D_2$ | 2.030  | 2.090 | 51.56       | 53.09  |
| H          | 1.020  | 1.060 | 25.91       | 26.92  |
| $\phi J$   | .135   | .145  | 3.43        | 3.68   |
| $J_1$      | .075   | .090  | 1.91        | 2.29   |
| L          | 7.75   | 8.50  | 196.85      | 215.90 |
| N          | .040   |       | 1.02        |        |

Creep Distance—1.00 in. min. (25.40 mm).  
Strike Distance—.69 in. min. (17.53 mm).  
(In accordance with NEMA standards)  
Finish—Nickel Plate.  
Approx. Weight—8 oz. (227 g).  
Dimension "H" is a clamped dimension.



## T82 Outline

### Features:

- Interdigitated, di/dynamic Gate structure
- Hard Commutation Turn-Off
- Forward Blocking Voltage Capabilities to 1200 Volts
- Low Switching Losses at High Frequency
- Soft Commutation (Feedback Diode) Testing Available
- High di/dt with soft gate control

### Applications:

- Induction Heating
- Transportation
- Inverters
- Crowbars
- Cycloconverters

## Ordering Information

| Type | Voltage                     |      | Current       |      | Turn-off        |      | Gate current  |      | Leads |      |
|------|-----------------------------|------|---------------|------|-----------------|------|---------------|------|-------|------|
|      | $V_{DRM}$ and $V_{RRM}$ (V) | Code | $I_T(av)$ (A) | Code | $t_q$ $\mu$ sec | Code | $I_{GT}$ (ma) | Code | Case  | Code |
| T82F | 100                         | 01   | 750           | 75   | 25              | B    | 200           | 3    | T82   | DN   |
|      | 200                         | 02   |               |      | 30              | 5    |               |      |       |      |
|      | 300                         | 03   |               |      | 40              | 4    |               |      |       |      |
|      | 400                         | 04   |               |      | 50              | 3    |               |      |       |      |
|      | 500                         | 05   |               |      | 60              | 2    |               |      |       |      |
|      | 600                         | 06   |               |      |                 |      |               |      |       |      |
|      | 700                         | 07   |               |      |                 |      |               |      |       |      |
|      | 800                         | 08   |               |      |                 |      |               |      |       |      |
|      | 900                         | 09   |               |      |                 |      |               |      |       |      |
|      | 1000                        | 10   |               |      |                 |      |               |      |       |      |
|      | 1100                        | 11   |               |      |                 |      |               |      |       |      |
|      | 1200                        | 12   |               |      |                 |      |               |      |       |      |

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Example: Obtain optimum device performance for your application by selecting proper Order Code.

Type T82F rated at 750 A average with  $V_{DRM} = 1000V$ ,  $I_{GT} = 200$  ma,  $t_q = 30 \mu$ sec max. and leads—order as:

| Type    | Voltage | Current | Turn Off | Gate Current | Leads |
|---------|---------|---------|----------|--------------|-------|
| T 8 2 F | 1 0 7 5 | 5       | 3        | D N          |       |

FAST SWITCHING  
THYRISTORS

# 750A Avg. (1180A RMS) Up to 1200 Volts 25-60 $\mu$ s

# Fast Switching SCR T82F

## Voltage ②

Blocking State Maximums ( $T_J = 125^\circ\text{C}$ )      **Symbol**

Repetitive peak forward blocking voltage, V .....  $V_{DRM}$   
 Repetitive peak reverse voltage, V .....  $V_{RRM}$   
 Non-repetitive transient peak reverse voltage,  
 $t \leq 5.0$  msec, V .....  $V_{RSM}$   
 Forward leakage current, mA peak .....  $I_{DRM}$   
 Reverse leakage current, mA peak .....  $I_{RRM}$

|     |     |     |     |     |     |     |     |      |      |      |      |
|-----|-----|-----|-----|-----|-----|-----|-----|------|------|------|------|
| 100 | 200 | 300 | 400 | 500 | 600 | 700 | 800 | 900  | 1000 | 1100 | 1200 |
| 100 | 200 | 300 | 400 | 500 | 600 | 700 | 800 | 900  | 1000 | 1100 | 1200 |
| 200 | 300 | 400 | 500 | 600 | 700 | 800 | 900 | 1000 | 1100 | 1200 | 1300 |

$\longleftrightarrow$  45  
 $\longleftrightarrow$  45

## Current

Conducting State Maximums  
( $T_J = 125^\circ\text{C}$ )

| Symbol   | T82F__75 |
|--|----------|
| RMS forward current, A ..... $I_T$ (rms)   | 1180     |
| Ave. forward current, A ..... $I_T$ (av)   | 750      |
| One-half cycle surge current ③, A ..... $I_{TSM}$  | 10000    |
| $I^2t$ for fusing (for times $\geq 8.3$ ms)<br>A <sup>2</sup> sec ..... $I^2t$                     | 416,000  |
| Forward voltage drop at $I_{TM} = 1500\text{A}$<br>and $T_J = 25^\circ\text{C}$ , V ..... $V_{TM}$ | 1.75     |
| Min. repetitive di/dt ①④⑥ A/ $\mu$ sec ..... di/dt   | 500      |

## Switching

( $T_J = 25^\circ\text{C}$ )

| Symbol  |                 |
|---|-----------------|
| Max. turn-off time, $I_T = 1000\text{A}$ , $T_J = 125^\circ\text{C}$ ,<br>$t_p = 100 \mu\text{sec}$ , di/dt = 50<br>A/ $\mu$ sec., reapplied dv/dt =<br>400 V/ $\mu$ sec linear to 0.8 $V_{DRM}$ , $\mu\text{sec}$ . ③⑦ | $t_q$ 25 to 60  |
| Typ. delay time, $I_{TM} = 1000\text{A}$<br>$T_D = .8 V_{DRM}$ ④, $\mu\text{sec}$   | $t_d$ .5        |
| Min. critical dv/dt exponential to .8<br>$V_{DRM}$ $T_J = 125^\circ\text{C}$ , V/ $\mu$ sec ② ⑤   | dv/dt      400  |
| Min. di/dt non-repetitive, A/ $\mu$ sec ①④⑥   | di/dt      1200 |

## Gate

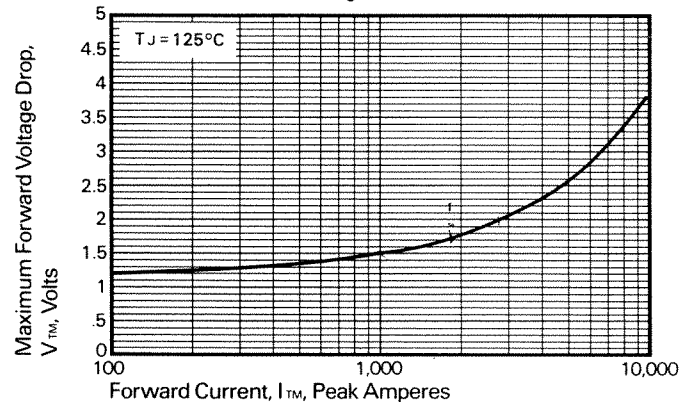
Maximum Parameters  
( $T_J = 25^\circ\text{C}$ )

| Symbol  |     |
|---|-----|
| Gate current to trigger at $V_D = 12\text{V}$ , mA ..... $I_{GT}$                                   | 200 |
| Gate voltage to trigger at $V_D = 12\text{V}$ , V ..... $V_{GT}$                                    | 3   |
| Non-triggering gate voltage, $T_J = 125^\circ\text{C}$ ,<br>and rated $V_{DRM}$ , V ..... $V_{GDM}$ | .25 |
| Peak forward gate current, A ..... $I_{GTM}$  | 4   |
| Peak reverse gate voltage, V ..... $V_{GRM}$  | 5   |
| Peak gate power, Watts ..... $P_{GM}$   | 16  |
| Average gate power, Watts ..... $P_{G(av)}$   | 3   |

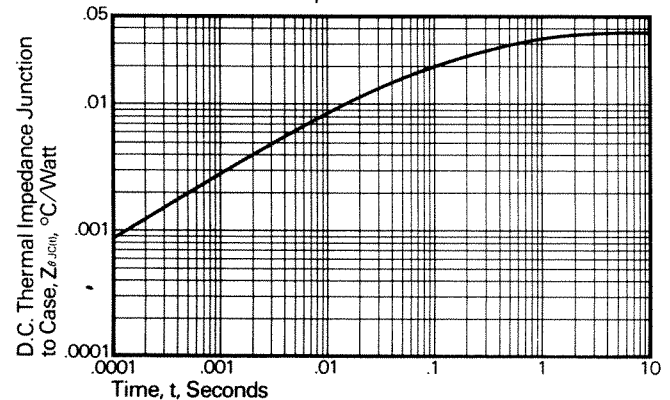
## Thermal and Mechanical

| Symbol   |              |
|--|--------------|
| Min., Max. oper. junction temp., $^\circ\text{C}$ ..... $T_J$  | -40 to +125  |
| Min., Max. storage temp., $^\circ\text{C}$ ..... $T_{stg}$   | -40 to +150  |
| Max. mounting force, lb. .... ①  | 3000 to 3500 |
| Thermal resistance ①, double-<br>side cooling, junction to case,<br>$^\circ\text{C}/\text{Watt}$ ..... $R_{\theta JC}$ | .037         |
| Case to sink, lubricated, $^\circ\text{C}/\text{Watt}$ ..... $R_{\theta cs}$   | .02          |

Maximum Forward Voltage VS. Forward Current



Transient Thermal Impedance VS. Time



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- ① Consult recommended mounting procedures.
- ② Applies for zero or negative gate bias.
- ③ Per JEDEC RS-397, 5.2.2.1.
- ④ With recommended gate drive.
- ⑤ Higher dv/dt ratings available, consult factory.
- ⑥ Per JEDEC standard RS-397, 5.2.2.6.
- ⑦ For operation with antiparallel diode, consult factory.